

$V_{RM} = 800\text{ V}$, $I_{F(AV)} = 0.5\text{ A}$, $t_{rr} = 200\text{ ns}$
Fast Recovery Diode
AB01B

Description

The AB01B is a fast recovery diode of 800 V / 0.5 A. The maximum t_{rr} of 200 ns is realized by optimizing a life-time control.

Features

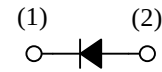
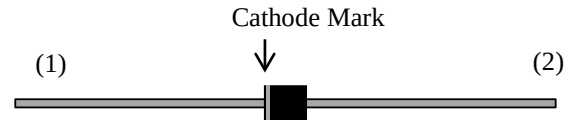
- V_{RM} ----- 800 V
- $I_{F(AV)}$ ----- 0.5 A
- V_F ----- 2.0 V
- t_{rr1} ----- 200 ns
- Bare Leads: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0

Applications

- Secondary-side Rectifier Diode
(Flyback Converter, LLC Converter, etc.)
- Freewheel Diode
(Offline Buck Converter, Offline Buck-boost Converter, etc.)

Package

Axial ($\phi 2.4 \times 2.9L / \phi 0.57$)



(1) Cathode
(2) Anode

Not to scale

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25\text{ }^{\circ}\text{C}$.

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage	V_{RSM}		800	V
Repetitive Peak Reverse Voltage	V_{RM}		800	V
Average Forward Current	$I_{F(AV)}$	See Figure 2 and Figure 3	0.5	A
Surge Forward Current	I_{FSM}	Half cycle sine wave, positive side, 10 ms, 1 shot	10	A
I^2t Limiting Value	I^2t	$1\text{ ms} \leq t \leq 10\text{ ms}$	0.5	A^2s
Junction Temperature	T_J		-40 to 150	$^{\circ}\text{C}$
Storage Temperature	T_{STG}		-40 to 150	$^{\circ}\text{C}$

Electrical Characteristics

Unless otherwise specified, $T_A = 25\text{ }^{\circ}\text{C}$.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage Drop	V_F	$T_J = 25\text{ }^{\circ}\text{C}$, $I_F = 0.5\text{ A}$	—	—	2.0	V
		$T_J = 100\text{ }^{\circ}\text{C}$, $I_F = 0.5\text{ A}$	—	1.0	—	V
Reverse Leakage Current	I_R	$V_R = V_{RM}$	—	—	10	μA
Reverse Leakage Current under High Temperature	$H \cdot I_R$	$V_R = V_{RM}$, $T_J = 150\text{ }^{\circ}\text{C}$	—	—	200	μA
Reverse Recovery Time	t_{rr1}	$I_F = I_{RP} = 100\text{ mA}$ 90% recovery point, $T_J = 25\text{ }^{\circ}\text{C}$	—	—	200	ns
	t_{rr2}	$I_F = 100\text{ mA}$, $I_{RP} = 200\text{ mA}$, 75% recovery point, $T_J = 25\text{ }^{\circ}\text{C}$	—	—	80	ns
Thermal Resistance ⁽¹⁾	$R_{th(J-L)}$	See Figure 1	—	—	22	$^{\circ}\text{C/W}$

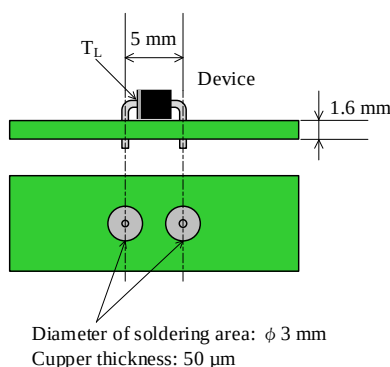


Figure 1. Lead Temperature Measurement Conditions

⁽¹⁾ $R_{th(J-L)}$ is thermal resistance between junction and lead.

Rating and Characteristic Curves

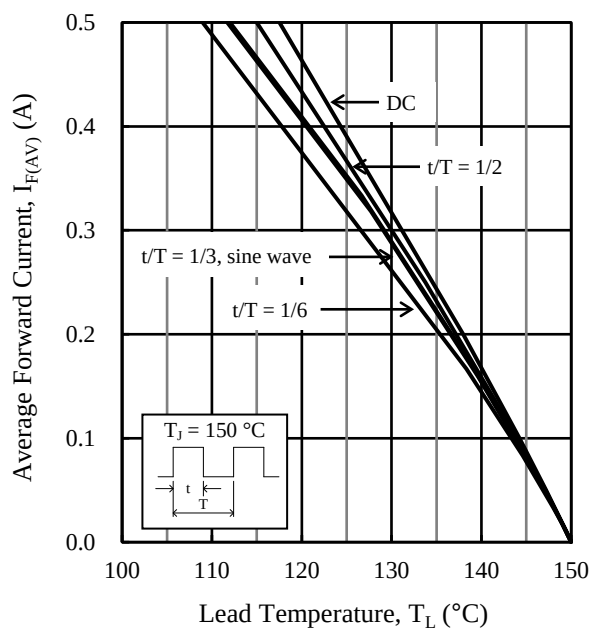


Figure 2. Typical Characteristics: $I_{F(AV)}$ vs. $T_L^{(2)}$
($V_R = 0$ V)

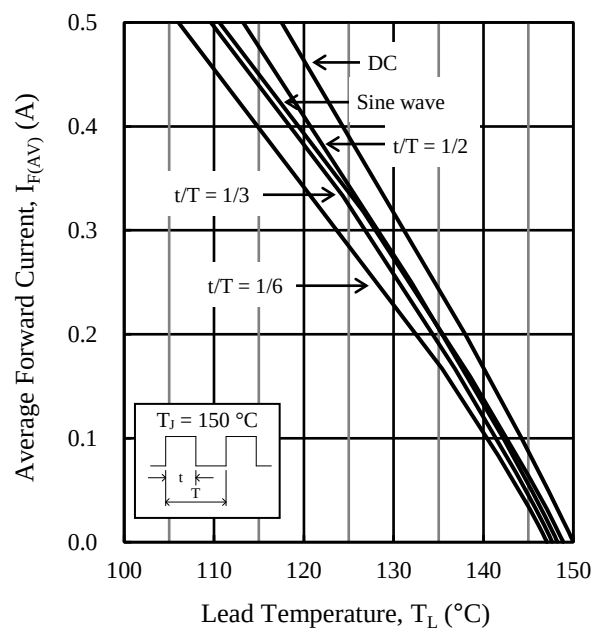


Figure 3. Typical Characteristics: $I_{F(AV)}$ vs. $T_L^{(2)}$
($V_R = 800$ V)

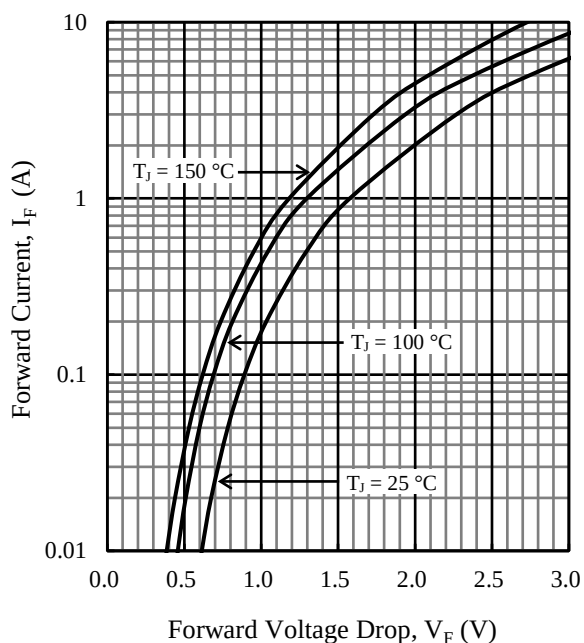


Figure 4. Typical Characteristics: I_F vs. V_F

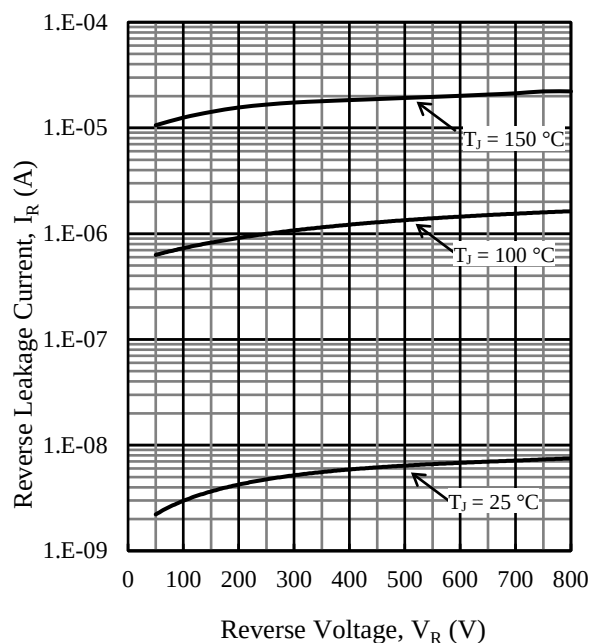
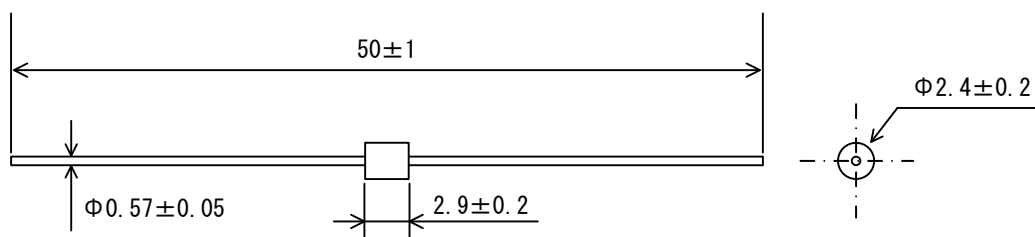


Figure 5. Typical Characteristics: I_R vs. V_R

⁽²⁾ See Figure 1 for the lead temperature measurement conditions.

Physical Dimensions

• Axial ($\phi 2.4 \times 2.9L / \phi 0.57$)



NOTES:

- Dimensions in millimeters
- Bare leads: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits:
 Flow: 260 ± 5 °C / 10 ± 1 s, 2 times
 Soldering Iron: 380 ± 10 °C / 3.5 ± 0.5 s, 1 time (Soldering should be at a distance of at least 1.5 mm from the body of the product.)

Marking Diagram

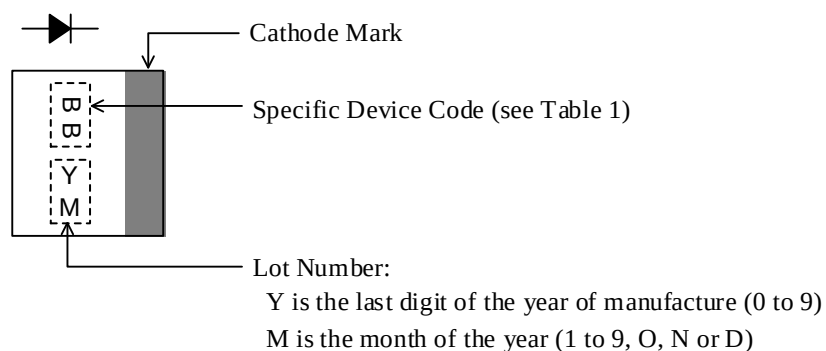


Table 1. Specific Device Code

Specific Device Code	Part Number
BB	AB01B

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